

AMENDMENT TRANSMITTAL LETTER

Docket No.
108298727US

Application No.

10/636,021-Conf. #1017

Filing Date

August 6, 2003

Examiner

E. B. Chen

Art Unit

1765

Applicant(s): Palsulich et al.

Invention: MICROFEATURE WORKPIECE PROCESSING SYSTEM FOR, e.g., SEMICONDUCTOR
WAFER ANALYSIS

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	35	- 48 =		x	
Independent Claims	4	- 5 =		x	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

☒ Large Entity☐ Small Entity☒ No additional fee is required for this amendment.☐ Please charge Deposit Account No. _____ in the amount of \$ _____.
A duplicate copy of this sheet is enclosed.☐ A check in the amount of \$ _____ to cover the filing fee is enclosed.☐ Payment by credit card. Form PTO-2038 is attached.☒ The Director is hereby authorized to charge and credit Deposit Account No. 50-0665
as described below.☒ Credit any overpayment.☒ Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

Chen Liang

Attorney/Agent Reg. No.: 51,945

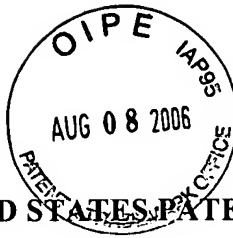
PERKINS COIE LLP

P.O. Box 1247

Seattle, Washington 98111-1247

(206) 359-8000

Dated: August 8, 2006



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: DAVID A. PALSULICH ET AL.
APPLICATION No.: 10/636,021
FILED: AUGUST 6, 2003
FOR: **MICROFEATURE WORKPIECE
PROCESSING SYSTEM FOR, E.G.,
SEMICONDUCTOR WAFER ANALYSIS**

EXAMINER: ERIC B. CHEN
ART UNIT: 1765
CONF. No: 1017

Amendment Under 37 C.F.R. § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated May 8, 2006 in the above-identified application. Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims beginning on page 2.